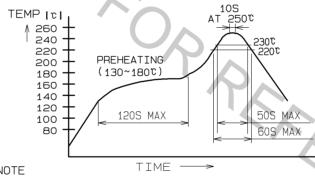
ENBOSSED TAPING DRAWING(4:1) DIRECTION OF UNREELING $75 \pm 0.$ 2±0.1 4±0.1 CENTER CONTACT 5.5 ± 0.1 12 ± 0.3 8 ± 0.1 (0.8) (1.2)

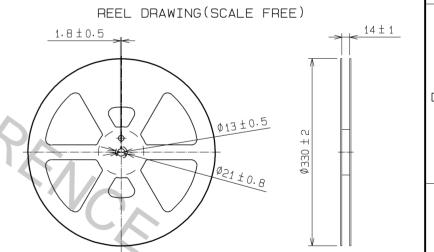
2.2 ± 0.1

MOUNTING TEMPERATURE PROFILE (REFERENCE)



MOUNTING TEMPERATURE PROFILE VARIES ACCORDING TO BOARD SIZE, SOLDER TYPE APPLIED AND SOLDER THICKNESS.

·METAL MASK THICKNESS: 0.1mm / 0.12mm ·Up to 2cycles of Reflow.



5000PCS/PLASTIC REEL

	2	BRASS			GOLD PLATING									
	1 PHOSPHOR BRONZE			SILVER PLATING				3	LCP	(BLACK), UL94V-0				
	NO. MATERIAL			FINISH , REMARKS				NO.	MA	TERIAL FINISH , REMARKS			ARKS	
	UNIT	TS	$\oplus \Box$	SC	CALE	COUNT	DESCRIP	TION	OF REVI	SIONS	DESIGNED		CHECKED	DATE
	m m		$\Psi \Box$		10:1 A 2 DIS-D-0			0137	'8		YI. FUNADA		NK. NINOMIYA	09. 03. 12
	■ ■ HIROSE								RAWING NO.	EDC3-138509-40				
	н	ŹC	ELECTR	I C						PART NO.	W. FL-R-SMT-1(40)			
- 1	4 6		CO LTD.		DESIGNED : NK. NINOMIYA				CI	005		-0482-6-40		
					DRAWN	: NK. NIN	AYIMC	06.	11. 02	NO.	UL331	- U 4	82-0-40	$ \angle 1 \rangle / 1$

FORM HC0011-5-7 1

PLACE ATTENTION REQUIRED: HARSH TEMPERATURE CHANGE.

AND HYDROGEN CHLORIDE GAS)

VOLCANIC MOUNTAIN AND ALIKE,

WATER SPLACHED AND CONDENSATION PLACES

As shown below due to possible product deterioration.

SPECIAL GAS ATMOSPHERE(HYDROGEN SULFIDE GAS, SULFUR SULFIDE GAS

PLACE ATTENTION REQUIRED: HEATING SYSTEM, AREA NEAR HOT SPRING,

MATERIAL: PS(BLACK)